| M <br> Magnetec | Product specification <br> for inductive components | Form: <br> Revision: | MF04.05 (F108) <br> 02 |
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| Client: | MAGNETEC GmbH | Magnetec <br> P/N: | M-310 |  |  |  |  |  |
| :--- | :--- | :--- | :--- | :--- | :--- | :---: | :---: | :---: |
| Client's P/N: | $/$ | PS Index: | 02 | PS Revision: | 04 |  |  |  |
| Subject: | EMC Wandler |  |  |  |  |  |  |  |


3. Inspection values (at room temperature, unless otherwise stated)

| Measured value | Measurement limits | Frequency | leff $\times \mathrm{N}[\mathrm{mA} \times$ turn $]$ |
| :--- | :---: | :---: | :---: |
| AL $[\mu \mathrm{H}]$ | $2,1-4,2$ | 10 kHz | 30 |
| AL $[\mu \mathrm{H}]$ | $1,26-\mathrm{NA}$ | 100 kHz | 30 |


| 4. Core finishing |  |
| :--- | :--- |
| Type: | Cased |
| Marking: | MAGNETEC M-310-02 YM (YM = Year/Month), acc. to IEC 600626.1 .1 |
| Packaging: | 24 pcs. per layer; 9 layers per carton box; PU = 216 pcs. |

5. Comments

Visit http://www.magnetec.de/fileadmin/pdf/pb ds.pdf for further information.

| Index / Rev |  | Alteration |  |  |  |  |  | Date |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\begin{aligned} & 02 / 01 \\ & 02 / 02 \\ & 02 / 03 \\ & 02 / 0 \end{aligned}$ |  | Product Specification <br> Packaging: $\mathrm{PU}=216 \mathrm{pcs}$. <br> 100 kHz lower limit defined <br> 100kHz lower limit increased by $20 \%$ |  |  |  |  |  | $\begin{aligned} & \hline 05.10 .2006 \\ & 06.12 .2006 \\ & 14.11 .2014 \\ & 16.05 .2018 \end{aligned}$ |
| Created: |  | Pádár $05.2018$ | Approved (Techn): | $\begin{aligned} & \hline \text { F. Zámborszky } \\ & 08.06 .2018 \end{aligned}$ | Approved (Quality): | R. Montvai 28.05.2018 | Released: | $\begin{gathered} \hline \text { P. Seiz } \\ 23.11 .2018 \end{gathered}$ |

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